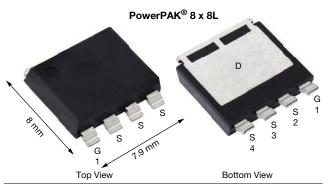
www.vishay.com

Vishay Siliconix

N-Channel 150 V (D-S) 175 °C MOSFET



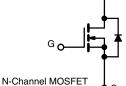
PRODUCT SUMMARY							
V _{DS} (V)	150						
$R_{DS(on)}$ max. (Ω) at V_{GS} = 10 V	0.0041						
$R_{DS(on)}$ max. (Ω) at V_{GS} = 7.5 V	0.0044						
Q _g typ. (nC)	93						
I _D (A) ^a	174						
Configuration	Single						

FEATURES

- TrenchFET[®] Gen V power MOSFET
- Fully lead (Pb)-free device
- Very low R_{DS} x Q_g figure of merit (FOM)
- Up to 174 A maximum continuous drain current
- 50 % smaller footprint than D²PAK (TO-263)
- 100 % R_{α} and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Synchronous rectification
- OR-ing
- Motor drive control
- Battery management



D

ORDERING INFORMATION	
Package	PowerPAK 8 x 8L
Lead (Pb)-free and halogen-free	SIJH5700E-T1-GE3

PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-source voltage		V _{DS}	150	V	
Gate-source voltage		V _{GS}	±20		
	T _C = 25 °C		174		
	T _C = 70 °C		138		
Continuous drain current (T _J = 175 °C)	T _A = 25 °C	I _D	17 ^b		
	T _A = 70 °C		15 ^b	Α	
Pulsed drain current (t = 100 µs)		I _{DM}	500		
Continuous source-drain diode current	T _C = 25 °C		303		
Continuous source-drain diode current	T _A = 25 °C	I _S	3 b		
Single pulse avalanche current		I _{AS}	40		
Single pulse avalanche energy L = 0.1 mH		E _{AS}	80	mJ	
	T _C = 25 °C		333		
Maximum power dissipation	T _C = 70 °C	P _D	233	w	
Maximum power dissipation	T _A = 25 °C	FD	3.3 ^b	vv	
	T _A =70 °C	1	2.3 ^b		
Operating junction and storage temperature	e range	T _J , T _{stg}	-55 to +175	°C	
Soldering recommendations (peak tempera		260			

THERMAL RESISTANCE RATINGS							
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT		
Maximum junction-to-ambient b	Steady state	R _{thJA}	36	45	°C/W		
Maximum junction-to-case (drain)	Steady state	R _{thJC}	0.36	0.45	0/10		

Notes

a. $T_C = 25 \ ^{\circ}C$

b. Surface mounted on 1" x 1" FR4 board
c. See solder profile (www.vishay.com/doc?73257). The PowerPAK 8 x 8L is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
d. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components

1

S22-0138-Rev. A, 14-Feb-2022

For technical questions, contact: pmostechsupport@vishay.com THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishav.com/doc?91000

RoHS

COMPLIANT

HALOGEN FREE

www.vishay.com

SiJH5700E Vishay Siliconix

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static				•		
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 V, I_D = 1 mA$	150	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	I _D = 10 mA	-	86	-	
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	-	-9.5	-	mV/°C
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	2	-	4	V
Gate-source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20$	-	-	100	nA
Zara gata valtaga drain aurrant	1	$V_{DS} = 120 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	1	
Zero gate voltage drain current	IDSS	V_{DS} = 120 V, V_{GS} = 0 V, T_{J} = 70 °C	-	-	15	μA
Drain actures on state registeres à	D	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 20 \text{ A}$	-	0.0034	0.0041	Ω
Drain-source on-state resistance ^a	R _{DS(on)}	$V_{GS} = 7.5 \text{ V}, \text{ I}_{D} = 20 \text{ A}$	-	0.0036	0.0044	52
Forward transconductance ^a	9 _{fs}	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 70 \text{ A}$	-	175	-	S
Dynamic ^b						
Input capacitance	C _{iss}		-	7500	-	
Output capacitance	C _{oss}	V_{DS} = 75 V, V_{GS} = 0 V, f = 1 MHz	-	620	-	pF
Reverse transfer capacitance	verse transfer capacitance C _{rss}		-	12	-	
Total gata obarga	0	$V_{DS} = 75 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$	-	93	140	
Total gate charge	Qg		-	70	105	
Gate-source charge	Q _{gs}	V_{DS} = 75 V, V_{GS} = 7.5 V, I_{D} = 20 A	-	36	-	nC
Gate-drain charge	Q _{gd}	- 8		8	-	
Gate resistance	stance R _g f = 1 MHz		0.36	1.8	3.6	Ω
Turn-on delay time	t _{d(on)}		-	28	60	
Rise time	tr	V_{DD} = 75 V, R_L = 7.5 Ω , $I_D \cong$ 10 A,	-	20	40	
Turn-off delay time	t _{d(off)}	V_{GEN} = 10 V, R_g = 1 Ω	-	45	90	
Fall time	t _f		-	45	90	-
Turn-on delay time	t _{d(on)}		-	24	50	ns
Rise time	t _r	$V_{DD} = 75 \text{ V}, \text{ R}_{L} = 7.5 \Omega, \text{ I}_{D} \cong 10 \text{ A},$	-	33	70	-
Turn-off delay time	t _{d(off)}	V_{GEN} = 7.5 V, R_g = 1 Ω	-	41	80	
Fall time	t _f		-	46	90	
Drain-Source Body Diode Characteris	tics					
Continuous source-drain diode current	I _S	T _C = 25 °C	-	-	303	A
Pulse diode forward current	I _{SM}		-	-	500	А
Body diode voltage	V _{SD}	$I_{S} = 10 \text{ A}, V_{GS} = 0 \text{ V}$	-	0.75	1.1	V
Body diode reverse recovery time	t _{rr}		-	197	400	ns
Body diode reverse recovery charge	Q _{rr}	L = 10.0 dt/dt = 100.0 / up T = 05.00	-	1480	2960	nC
Reverse recovery fall time	t _a	$I_F = 10 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^\circ\text{C}$	-	141	-	20
Reverse recovery rise time	t _b		-	56	-	ns

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

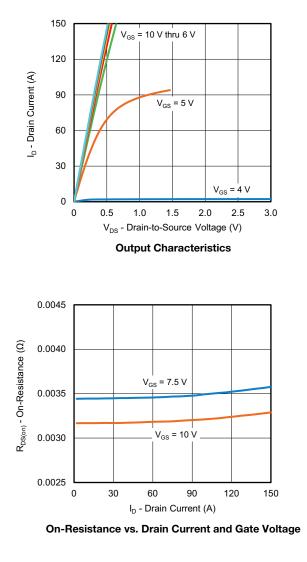
2

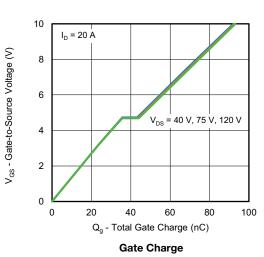
For technical questions, contact: <u>pmostechsupport@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>

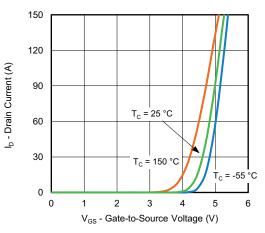


Vishay Siliconix

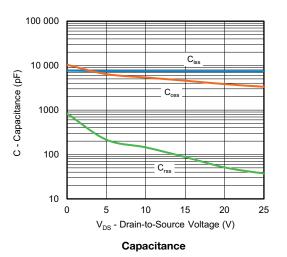
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

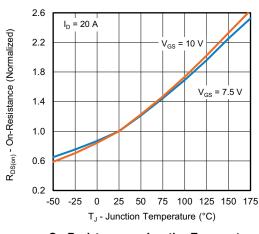






Transfer Characteristics





On-Resistance vs. Junction Temperature

S22-0138-Rev. A, 14-Feb-2022

3

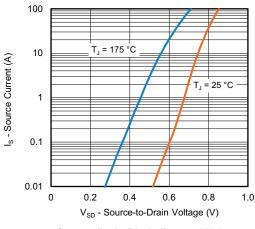
Document Number: 62052

For technical questions, contact: <u>pmostechsupport@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>

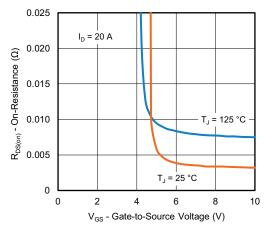


Vishay Siliconix

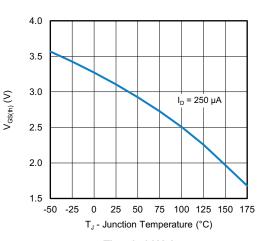
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



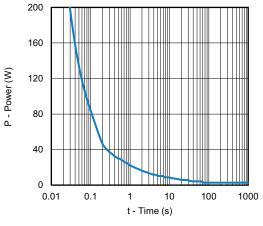
Source-Drain Diode Forward Voltage



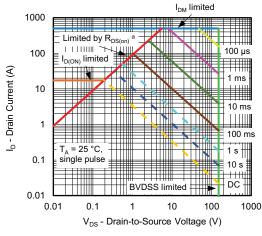
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient

Note

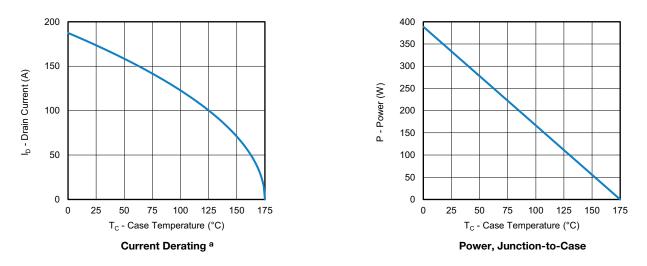
a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

For technical questions, contact: <u>pmostechsupport@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>



Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



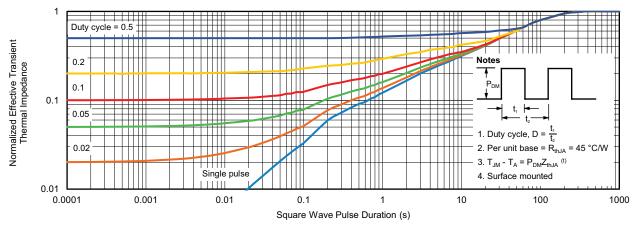
Note

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

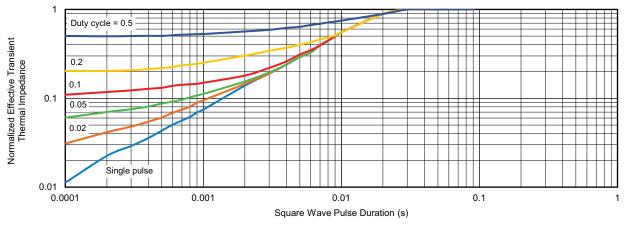


Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

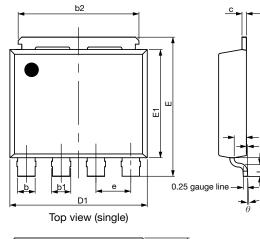
Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?62052.

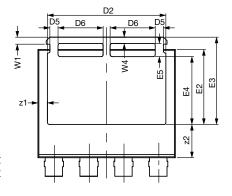
6

Vishay Siliconix

PowerPAK[®] 8 x 8L BWL Case Outline 2

A1





Bottom view (single)

1						_ ↑
F	-		-	-	A.	<
l	_					

DIM.		MILLIMETERS			INCHES	
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
А	1.50	1.60	1.70	0.059	0.063	0.067
A1	0.00	-	0.127	0.000	-	0.005
A2	0.655	0.705	0.755	0.026	0.028	0.030
b	0.92	1.00	1.08	0.036	0.039	0.043
b1	1.02	1.10	1.18	0.040	0.043	0.046
b2	6.84	6.94	7.04	0.269	0.273	0.277
С	0.20	0.25	0.30	0.008	0.010	0.012
D1	7.80	7.90	8.00	0.307	0.311	0.315
D2	6.70	6.80	6.90	0.264	0.268	0.272
D5	0.37	0.47	0.57	0.015	0.019	0.022
D6	2.49	2.59	2.69	0.098	0.102	0.106
е	1.97	2.00	2.03	0.078	0.079	0.080
Е	7.90	8.00	8.10	0.311	0.315	0.319
E1	6.12	6.22	6.32	0.241	0.245	0.249
E2	4.21	4.31	4.41	0.166	0.170	0.174
E3	4.92	5.02	5.12	0.194	0.198	0.202
E4	3.80	3.90	4.00	0.150	0.154	0.157
E5	0.65	0.75	0.85	0.026	0.030	0.033
L	0.61	0.68	0.75	0.024	0.027	0.030
L1	1.00	1.07	1.15	0.039	0.042	0.045
W1	0.30	0.40	0.50	0.012	0.016	0.020
W4	0.32	0.37	0.42	0.013	0.015	0.017
z1	0.45	0.55	0.65	0.018	0.022	0.026
z2	1.81	1.91	2.01	0.071	0.075	0.079
θ	0°	-	5°	0°	-	5°
N: S19-0643-F G: 6073	lev. B, 05-Aug-2019					

Note

• Millimeter will govern

VISHAY

www.vishay.com

Revison: 05-Aug-2019



Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.